## CRMQGL0405A

#### N-Channel 40V, 4.1mΩ Typ. Power MOSFET

### **Description**

#### **Features**

• 40V, 55A

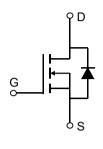
$$R_{DS(ON)}$$
 Typ = 4.1m $\Omega$  @  $V_{GS}$  = 10V

$$R_{DS(ON)}$$
 Typ = 7.5m $\Omega$  @  $V_{GS}$  = 4.5V

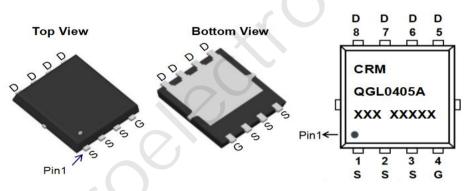
- Advanced Split Gate Trench Technology
- Excellent R<sub>DS(ON)</sub> and Low Gate Charge
- Lead Free
- 100% UIS TESTED!
- 100% ΔVds TESTED!

### **Application**

- Load Switch
- PWM Application
- Power Management







**Marking and Pin Assignment** 

#### **Package Marking and Ordering Information**

| Device      | Marking     | Package        | Outline | Reel Size | Reel (pcs) | Per Carton (pcs) |
|-------------|-------------|----------------|---------|-----------|------------|------------------|
| CRMQGL0405A | CRMQGL0405A | PDFN3.3x3.3-8L | TAPING  | 13"       | 5000       | 50000            |

#### Absolute Maximum Ratings (@ T<sub>J</sub> = 25°C unless otherwise specified)

| Symbol          | Parameter                            |                        | Value      | Units |
|-----------------|--------------------------------------|------------------------|------------|-------|
| $V_{DS}$        | Drain-to-Source Voltage              |                        | 40         | V     |
| V <sub>GS</sub> | Gate-to-Source Voltage               |                        | ±20        | V     |
|                 | Continuous Drain Current             | T <sub>C</sub> = 25°C  | 55         | Α     |
| I <sub>D</sub>  | Continuous Drain Current             | T <sub>C</sub> = 100°C | 33         | А     |
| I <sub>DM</sub> | Pulsed Drain Current (1)             |                        | 220        | Α     |
| E <sub>AS</sub> | Single Pulsed Avalanche Energy (2)   |                        | 49         | mJ    |
| $P_{D}$         | Power Dissipation                    | T <sub>C</sub> = 25°C  | 28         | W     |
| $R_{	heta JC}$  | Thermal Resistance, Junction to Case |                        | 4.5        | °C/W  |
| $T_J,T_STG$     | Junction & Storage Temperature Range |                        | -55 to 150 | °C    |

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#### **Electrical Characteristics** (T<sub>J</sub> = 25°C unless otherwise specified)

| Symbol               | Parameter  | Conditions  | Min.       | Тур. | Max. | Uni |
|----------------------|--|---|------------|------|------|-----|
| Off Chara            | acteristics                                      |   |            |      |      |     |
| V <sub>(BR)DSS</sub> | Drain-Source Breakdown Voltage                   | $I_D = 250 \mu A, V_{GS} = 0 V$                             | 40         | -    | -    | V   |
| I <sub>DSS</sub>     | Zero Gate Voltage Drain Current                  | $V_{DS} = 40V, V_{GS} = 0V$                                 | -          | -    | 1.0  | μΑ  |
| I <sub>GSS</sub>     | Gate-Body Leakage Current                        | $V_{DS} = 0V, V_{GS} = \pm 20V$                             | -          | -    | ±100 | nA  |
| On Chara             | acteristics                                      |   |            |      | 6    |     |
| $V_{GS(th)}$         | Gate Threshold Voltage                           | $V_{DS} = V_{GS}, I_{D} = 250 \mu A$                        | 1          | 2    | 2.5  | V   |
| Б                    |  | $V_{GS} = 10V, I_D = 20A$                                   | -          | 4.1  | 5.3  | mΩ  |
| $R_{DS(ON)}$         | Static Drain-Source ON-Resistance <sup>(3)</sup> | V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 15A                | -          | 7.5  | 9.7  | mΩ  |
| Dynamic              | Characteristics                                  |   |            |      |      |     |
| C <sub>iss</sub>     | Input Capacitance                                |   |            | 1050 | -    | pF  |
| $C_{oss}$            | Output Capacitance                               | $V_{GS} = 0V, V_{DS} = 20V,$<br>f = 1MHz                    | X-\        | 450  | -    | pF  |
| $C_{rss}$            | Reverse Transfer Capacitance                     | 1 – 1101112   | - 1        | 15   | -    | pF  |
| $Q_g$                | Total Gate Charge                                |   | <b>J</b> . | 20   | -    | nC  |
| $Q_{gs}$             | Gate Source Charge                               | $V_{GS} = 0 \text{ to } 10V$<br>$V_{DS} = 20V, I_{D} = 20A$ | -          | 3.5  | -    | nC  |
| $Q_{gd}$             | Gate Drain("Miller") Charge                      | V <sub>DS</sub> - 20 V, I <sub>D</sub> - 20A                | -          | 4.4  | -    | nC  |
| Switchin             | g Characteristics                                |   |            |      |      |     |
| t <sub>d(on)</sub>   | Turn-On DelayTime                                | .( )  | -          | 5    | -    | ns  |
| t <sub>r</sub>       | Turn-On Rise Time                                | $V_{GS} = 10V, V_{DD} = 20V$                                | -          | 8.8  | -    | ns  |
| $t_{\text{d(off)}}$  | Turn-Off DelayTime                               | $I_D = 20A$ , $R_{GEN} = 6\Omega$                           | -          | 24   | -    | ns  |
| $t_{f}$              | Turn-Off Fall Time                               |   | -          | 15.5 | -    | ns  |
| Drain-So             | urce Diode Characteristics and M                 | Max Ratings   |            |      |      |     |
| Is                   | Maximum Continuous Drain to Source Di            | ode Forward Current   | -          | -    | 55   | А   |
| I <sub>SM</sub>      | Maximum Pulsed Drain to Source Diode             | Forward Current   | -          | -    | 220  | Α   |
| $V_{SD}$             | Drain to Source Diode Forward Voltage            | V <sub>GS</sub> = 0V, I <sub>S</sub> = 20A                  | -          | -    | 1.2  | V   |
| trr                  | Body Diode Reverse Recovery Time                 | I 00A 1771 400A7  | -          | 40   | -    | ns  |
| Qrr                  | Body Diode Reverse Recovery Charge               | $I_F = 20A$ , di/dt = 100A/us                               | _          | 42   | _    | nC  |

Notes:

<sup>1.</sup> Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

<sup>2.</sup>  $E_{AS}$  condition: Starting  $T_J$ =25°C,  $V_{DD}$ =30V,  $V_G$ =10V,  $R_G$ =25ohm, L=0.5mH,  $I_{AS}$ =14A

<sup>3.</sup> Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%.

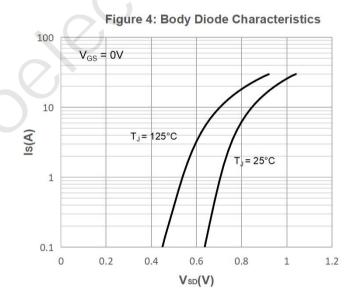
## **Typical Performance Characteristics**

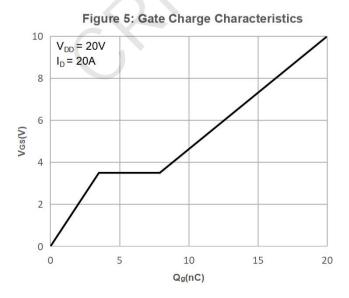
Figure 1: Output Characteristics 60 50 40 V<sub>GS</sub> = 3.6V **8** 30 20 10 0 1 2 3 0 VDs(V)

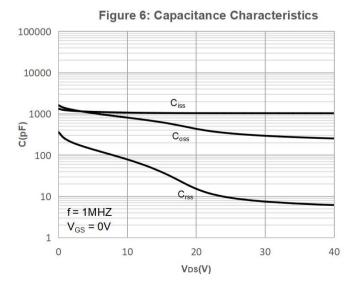
20  $V_{DS} = 5V$ 16 12 Ib(A) T<sub>J</sub> = 125°C 8 T<sub>J</sub>= 25°C 4 0 0 0.5 1.5 2 2.5 3.5 4.5 Vgs(V)

Figure 2: Typical Transfer Characteristics

Figure 3: On-resistance vs. Drain Current 10 9  $V_{GS} = 4.5V$ 8 RDS(ON)(MD) 5  $V_{GS} = 10V$ 3 2 1 0 0 28 21 35 lo(A)







## **Typical Performance Characteristics**

Figure 7: Normalized Breakdown voltage vs.
Junction Temperature

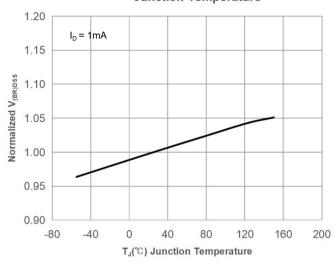


Figure 9: Maximum Safe Operating Area

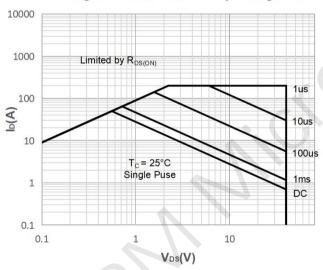


Figure 11: Normalized Maximum Transient

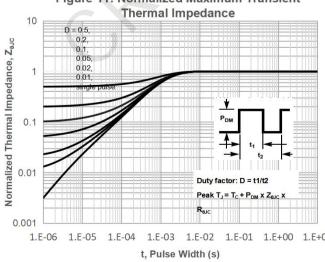


Figure 8: Normalized on Resistance vs. Junction Temperature

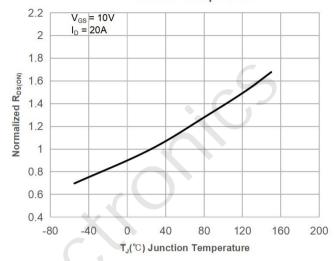


Figure 10: Maximum Continuous Drian
Current vs. Case Temperature

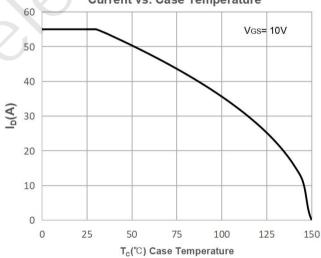
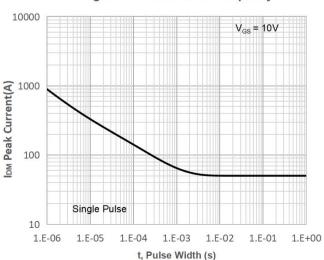


Figure 12: Peak Current Capacity



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#### **Test Circuit**

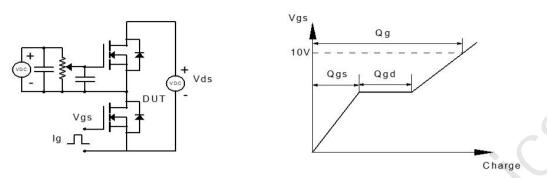


Figure 1: Gate Charge Test Circuit & Waveform

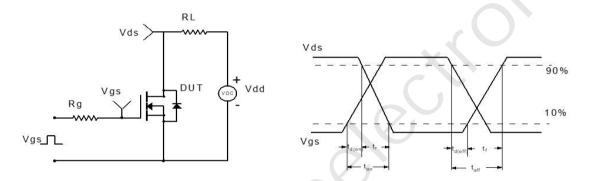


Figure 2: Resistive Switching Test Circuit & Waveform

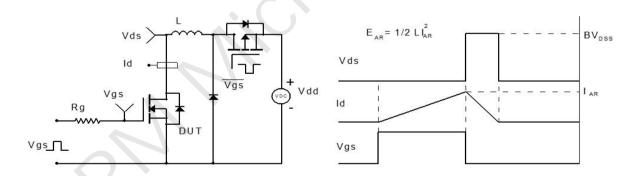


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

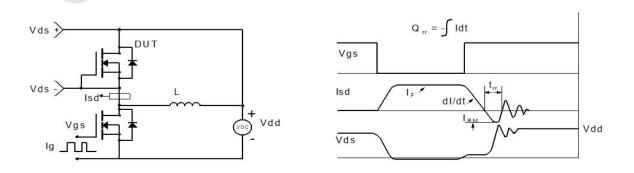
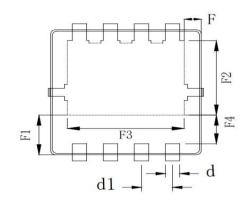


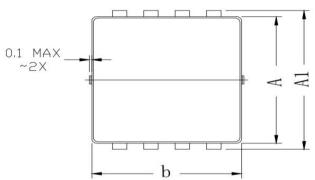
Figure 4: Diode Recovery Test Circuit & Waveform

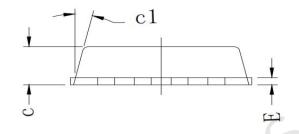
## CRMQGL0405A

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### Package Mechanical Data(PDFN3.3x3.3-8L)







|        | COMMON DIN      | MENSION (MM) |        |
|--------|-----------------|--------------|--------|
| PKG    | PDFN 3.3×3.3-8L |              |        |
| SYMBOL | MIN             | TYP          | MAX    |
| Α      | 3.070           | 3.100        | 3. 130 |
| A1     | 3. 300          | 3.400        | 3.500  |
| b      | 3.070           | 3. 100       | 3. 130 |
| С      | 0. 770          | 0.800        | 0. 830 |
| c1     | _               | 13°          |        |
| d      | 0. 275          | 0.300        | 0. 325 |
| d1     | 0.625           | 0.650        | 0. 675 |
| E      | 0. 144          | 0. 152       | 0. 160 |
| F      | 0. 300          | 0. 325       | 0. 350 |
| F1     | 0.960           | 0. 985       | 1.010  |
| F2     | 1. 775          | 1.800        | 1.825  |
| F3     | 2. 425          | 2. 450       | 2. 475 |
| F4     | 0.660           | 0. 685       | 0.710  |
| 1.1    | 0. 500          | 0.000        |        |

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